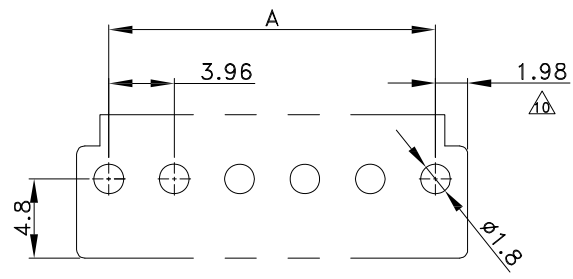


△ DIP Length: C:11.7mm

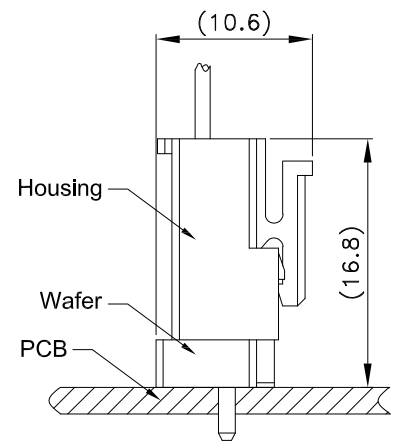
**NOTES:**

- Material:**  
 Housing: Nylon 66, UL 94V-2 Rated.  
 Color: White.  
 Contact: Brass.  
 Plating: Tin Plating over Nickel.  
 Tin Plating on Solder tail.
- Electrical Specification:**  
 Operation Voltage: 250V AC/DC.  
 Current Rating: 7 Ampere AC/DC per Contact.  
 Contact Resistance: 10mΩ Max.  
 Insulation Resistance: 1000MΩ Min.  
 Dielectric Withstanding Voltage: 1500V AC per Minute.
- Environmental:**  
 Operating Temperature: -25°C to +85°C.

Poles	Dimensions (mm)	
	A	B
2	3.96	7.86
3	7.92	11.82
4	11.88	15.78
5	15.84	19.74
6	19.80	23.70
7	23.76	27.66
8	27.72	31.62
9	31.68	35.58
10	35.64	39.54
11	39.60	43.50
12	43.56	47.46
13	47.52	51.42
14	51.48	55.38
15	55.44	59.34



**Recommend PCB Layout**  
 General Tolerance±0.05




**Assemble State**

**Part Number:**

**CW39-MXXVDT1-20**

- Wafer 3.96mm Series
- M: Male Type
- XX: 02~15Pins
- V: Vertical Type
- D: DIP Type
- T: Tin Plating
- Pin Length: Blank: DIP=3.6mm
- A: DIP=3.2mm
- B: DIP=2.7mm
- C: DIP=11.7mm
- Product Number: B1: L=18.0mm, DIP=7.4mm
- 1: White Color

A	02/26/14	RELEASED FOR PRODUCTION	
REV	DATE	DESCRIPTION	
UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN MM. TOLERANCES ARE:		CAD GENERATED DRAWING, DO NOT MANUALLY UPDATE	
DECIMALS	ANGLES	APPROVALS	DATE
.X ± .38	± 3°	DRAWN Chris	02/26/14
.XX ± .25		CHECKED Cindy	02/26/14
.XXX ± .20		APPV Jason	02/26/14
DO NOT SCALE DRAWING	SHEET 1 OF 1	SCALE NONE	DWG. NO. CW39-MXX-020
		 <b>凱聯科技股份有限公司</b> <b>Conn-Link Technology Inc.</b>	
		DESCRIPTION <b>3.96mm Wire to Board Connector, Wafer Vertical, DIP 02~15Pins, White</b>	
		REV.	A